

SPECIFICATION

Model No. : SGGP.18A

Product Name : GPS/GLONASS SMT Patch Antenna

Features : 18mm*18mm*4mm

Single Feed SMT GPS: 1575MHz

GLONASS: 1602MHz

Patent pending

RoHS ✓

Photo :





1. Introduction

This ceramic 18mm GPS/GLONASS patch antenna is mounted via SMT process and has been pre-tuned for a 50*50mm ground plane. Custom part no's tuned for different ground-plane or layout positions and taking into account the specific conditions in your device can be created and supplied by Taoglas.

2. Specification

Original Patch Specification tested on 50*50mm ground plane

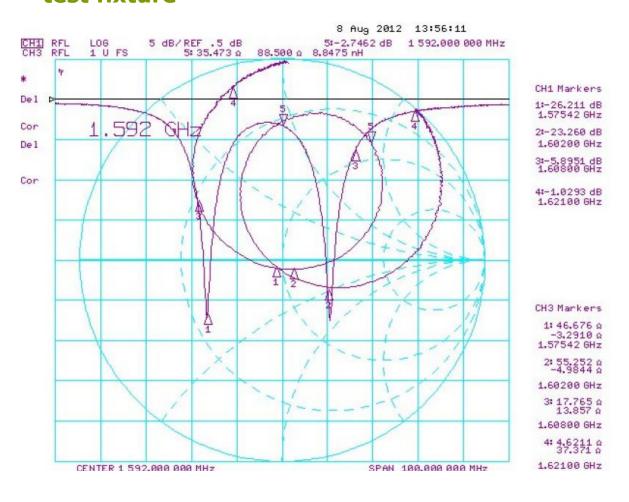
| Original Patch Specification tested on 50 Somm ground plane | | | |
|---|---|---|---------------------------|
| No | Parameter | Specification | Notes |
| 1 | Range of Receiving | GPS:1575.42 MHz ± 1.023 MHz | |
| | Frequency | GLONASS: 1602± 5 MHz | |
| 2 | Center Frequency | 1592± 3MHz | With 50*50mm ground plane |
| 3 | Bandwidth | 8MHz min | Return Loss <-10 dB |
| 4 | VSWR | 1.5 max | |
| 5 | Gain at Zenith | GPS: 0.26dBic typ. GLONASS: 1.25dBic typ. | Center Frequency |
| 6 | Impedance | 50 Ohms | |
| 7 | Frequency Temperature Coefficient (Tf) | 0 ± 20ppm / °C | -40°C to +85°C |
| 8 | Operating Temperature -40°C to +85°C | | |

^{**}Changes in user groundplane and environment will offset centre frequency



3. Electrical Specifications

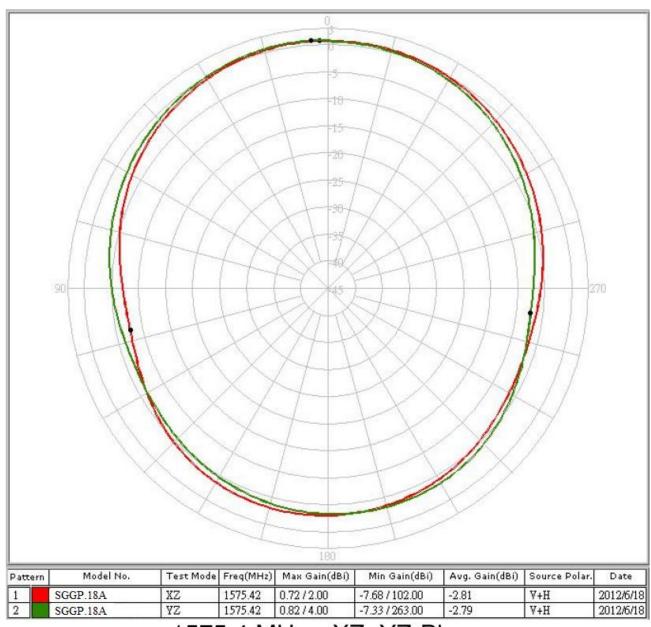
3.1 Return Loss, SWR, Impedance, measured on the test fixture





4. Radiation Patterns

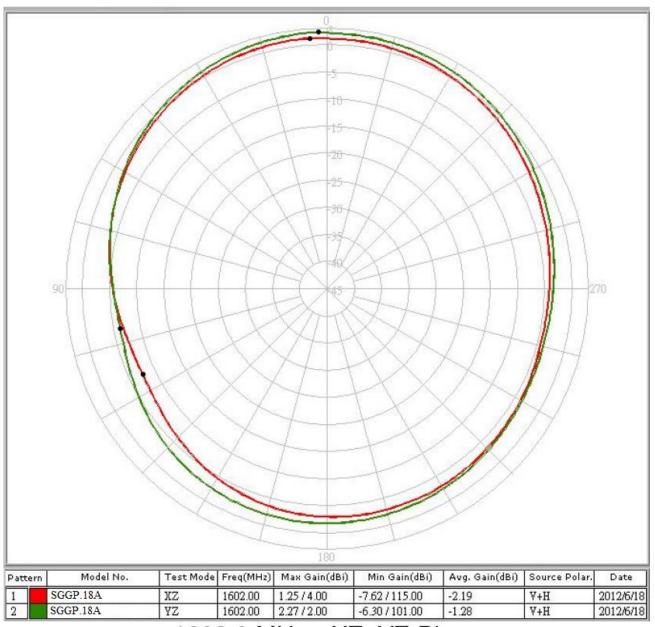
4.1 1575MHz



1575.4 MHz XZ+YZ-Plane



4.2 1602MHz

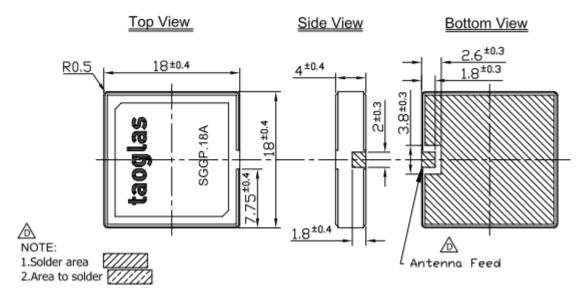


1602.0 MHz XZ+YZ-Plane



5. Mechanical Specifications

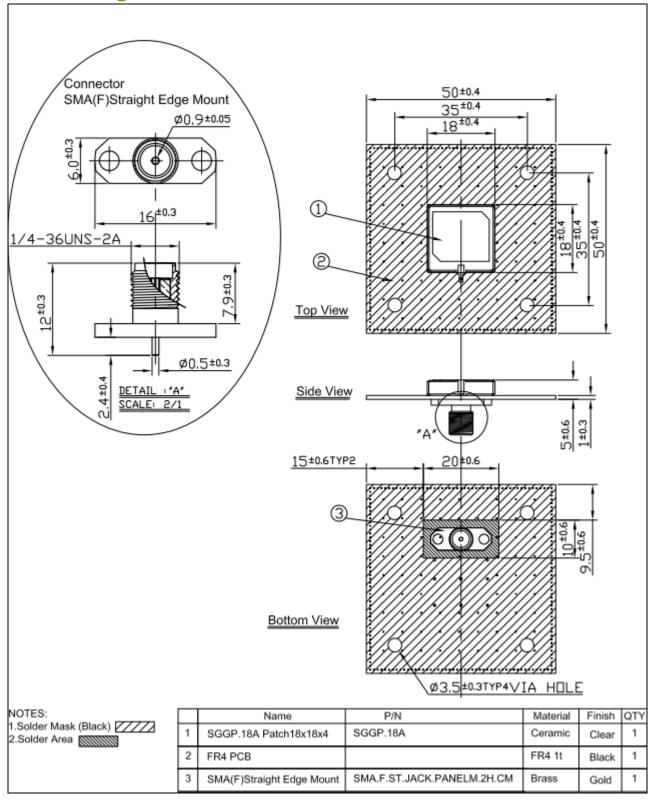
5.1 Antenna Dimensions and Drawing



Contact Taoglas Engineering for Footprint Information at support@taoglas.com

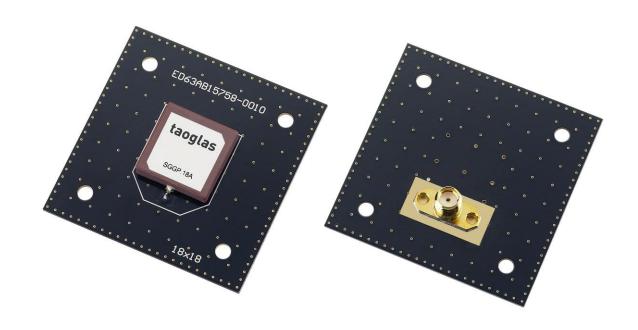


5.2 Test Jig and Dimension – SGGP.18A





5.3 SGGPD.18A





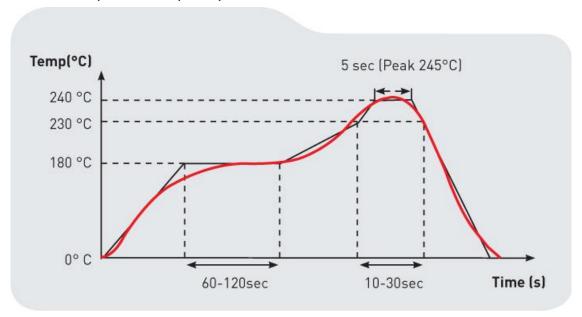
6. Antenna Recommended Soldering Conditions

6.1 Flux, Solder

- Use rosin-based flux. Don't use highly acidic flux with halide content exceeding 0.2wt%(chlorine conversion value).
- Use Sn solder.

6.2 Reflow soldering conditions

 Pre-heating should be in such a way that the temperature difference between solder and product surface is limited to 150°C max. Cooling into solvent after soldering also should be in such a way that temperature difference is limited to 100°C max. Unwrought pre-heating may cause cracks on the product, resulting in the deterioration of products quality.



6.3 Reworking with soldering iron

• The following conditions must be strictly followed when using a soldering iron.

| Pre-heating | 150°C, 1 min | |
|-----------------------|--------------|--|
| Tip temperature | 290°C max | |
| Soldering iron output | 30w max | |
| Soldering time | 3 second max | |



7. Packaging

200 pcs/Reel/Inner Carton5 Reels in an outer carton

